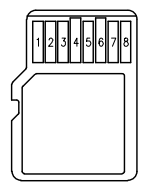
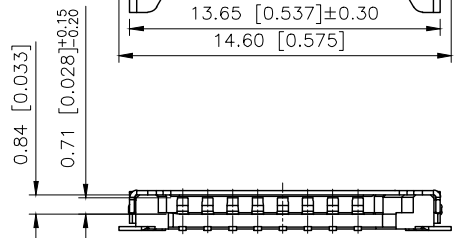
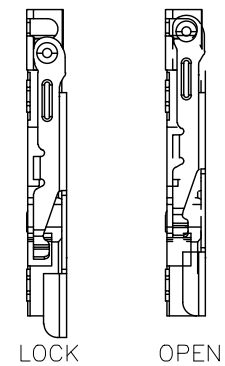
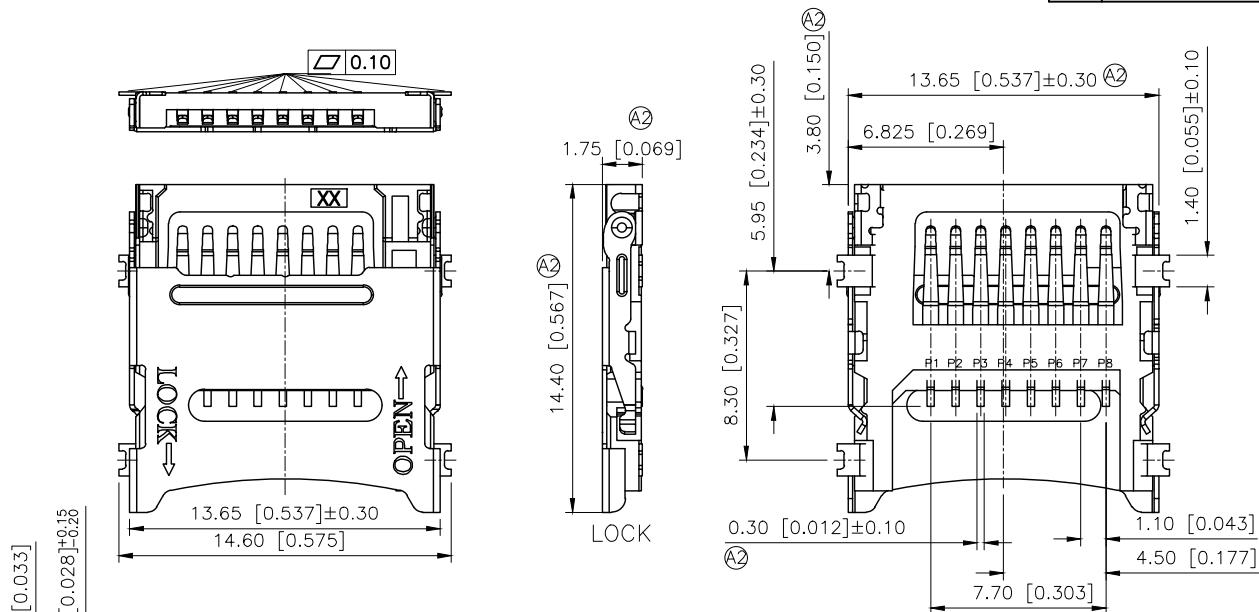
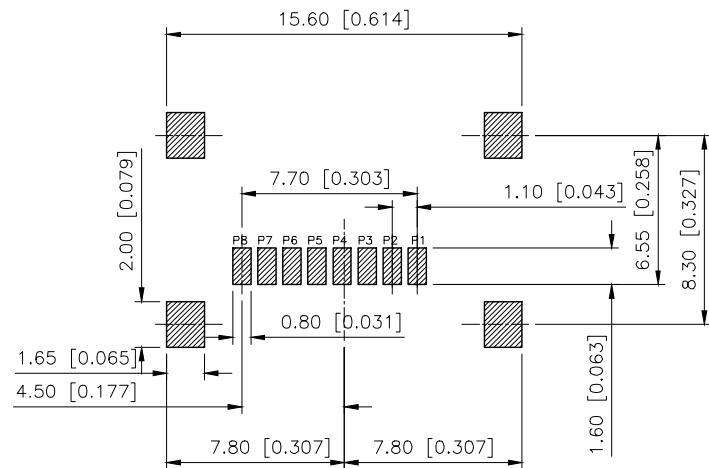


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A1	N/A			2025.05.16	
A2	N/A	A2X5		2025.10.23	



T-FLASH CARD

PIN NO.	PIN Assignmeng.
PIN1	DAT2
PIN2	CD/DAT3
PIN3	CMD
PIN4	VDD
PIN5	CLK
PIN6	Uss2
PIN7	DATO
PIN8	DAT1



- NOTES:
- MATERIAL:
 - HOUSING: LCP UL94V-0; COLOR: BLACK
 - TERMINAL: C2680
 - SHELL: SUS201
 - FINISH:
 - TERMINAL: G/F PLATED ON CONTACT AREA; Tin 50u". PLATED ON SOLDER AREA; Ni 20u" MIN. UNDERPLATED OVERALL.
 - SHELL: CLEANING
 - ELECTRICAL SPECIFICATION:
 - RATED CURRENT: 0.5A;
 - CONTACT RESISTANCE: 100mΩ MAX.
 - INSULATION RESISTANCE: 1000MΩ MIN AT 250V DC.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC.
 - ENVIRONMENTAL SPECIFICATION:
 - OPERATING CONDITION: TEMPERATURE-40°C~+85°C; HUMIDITY 80% R.H MAX
 - SALT SPRAY: 24H(Contact Area)
 - SOLDER ABILITY:245±5°C, 5±0.5s
 - IR REFLOW: THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN		VIEW:	MODEL TYPE: TF CARD CONN
CHECKED		UNIT: mm/in	PART NO.: XKTF-1307-18
APPROVED		SIZE: A4	DWG NO.: